#### **Features**

- Low on-state resistance
- Built-in gate protection diode

#### Package

MT100 (TO3P)



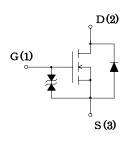
#### **Applications**

- Electric power steering
- High current switching

#### **Key Specifications**

- $V(BR)DSS=60V (ID=100\mu A)$
- RDS(ON)=4.7m $\Omega$  Max. (VGS=10V,ID=42A)

## **Internal Equivalent Circuit**



#### **Absolute maximum ratings**

Characteristic	Symbol	Rating	Unit
Drain to Source Voltage	$V_{\mathrm{DSS}}$	60	V
Gate to Source Voltage	$ m V_{GSS}$	±20	V
Continuous Drain Current	$I_{\mathrm{D}}$	$\pm85$	A
Pulsed Drain Current	$I_{D(pulse)}  {}^{st  1}$	± 280	A
Maximum Power Dissipation	$P_{\mathrm{D}}$	150 (Tc=25°C)	W
Single Pulse Avalanche Energy	E <sub>AS</sub> **2	280	mJ
Channel Temperature	Tch	-55~150	°C
Storage Temperature	Tstg	-55~150	°C

 $\%1 \text{ PW} \le 100 \,\mu \text{ sec. duty cycle} \le 1\%$ 

X2 VDD=20V, L=1mH, IL=20A, unclamped, See Fig.1



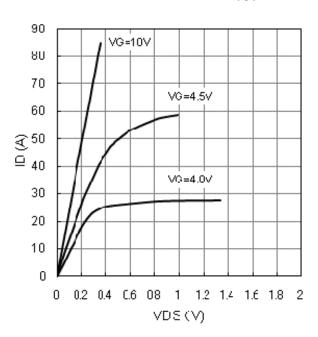
#### **Electrical characteristics**

 $(Ta=25^{\circ}C)$ 

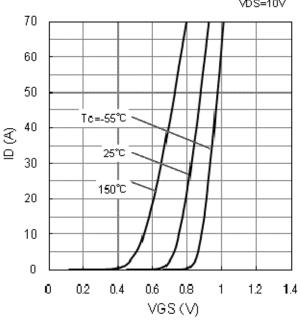
Characteristic	Symbol	Test Conditions	Limits			l lait
			MIN	TYP	MAX	Unit
Drain to Source breakdown Voltage	$V_{(BR)DSS}$	I <sub>D</sub> =100μA,V <sub>GS</sub> =0V	60			V
Gate to Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V			±10	μA
Drain to Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			100	μA
Gate Threshold Voltage	$V_{TH}$	V <sub>DS</sub> =10V, I <sub>D</sub> =1mA	2.0	2.5	3.0	V
Forward Transconductance	Re(yfs)	V <sub>DS</sub> =10V, I <sub>D</sub> =42A	30			S
Static Drain to Source On-Resistance	R <sub>DS(ON)</sub>	I <sub>D</sub> =42A, V <sub>GS</sub> =10V		4.0	4.7	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> =10V V <sub>GS</sub> =0V f=1MHz		11500		pF
Output Capacitance	Coss			1500		
Reverse Transfer Capacitance	Crss			1100		
Turn-On Delay Time	td(on)	$I_D$ =42A, $V_{DD}$ □16V - $R_G$ =22 $\Omega$ , $V_{GS}$ =10V See Fig.2		60		ns
Rise Time	tr			25		
Turn-Off Delay Time	td(off)			370		
Fall Time	tf			65		
Source-Drain Diode Forward Voltage	$V_{SD}$	I <sub>SD</sub> =50A,V <sub>GS</sub> =0V		0.87	1.5	V
Source-Drain Diode Reverse Recovery Time	trr	I <sub>SD</sub> =50A di/dt=100A/us		70		ns

### Characteristic Curves (Tc=25°C)

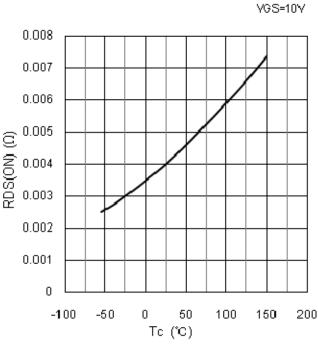
ID - VDS characteristics (typical)



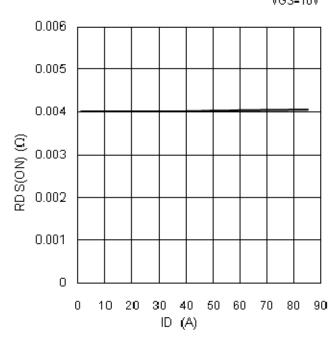
ID - VGS characteristics (typical) vbs=10



RDS(ON) - To characteristics (typical)



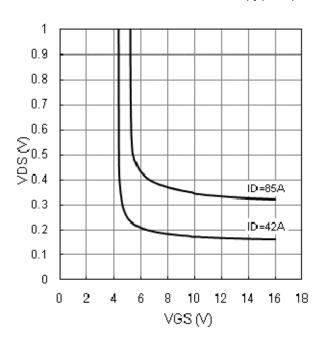
RDS(ON) - ID characteristics (typical)
VGS=10V



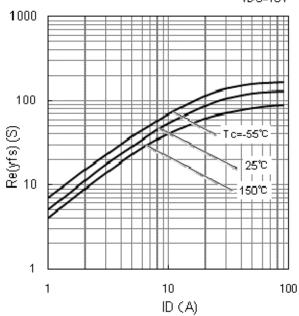
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## Characteristic Curves (Tc=25°C)

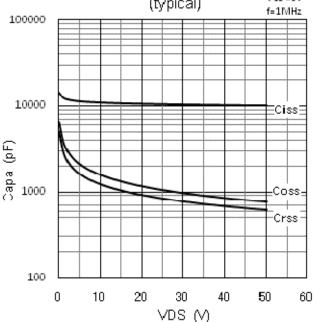
VDS - VGS characteristics (typical)



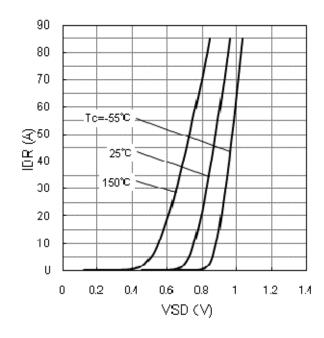
Re(yfs) - ID characteristics (typical)
VDS=10V



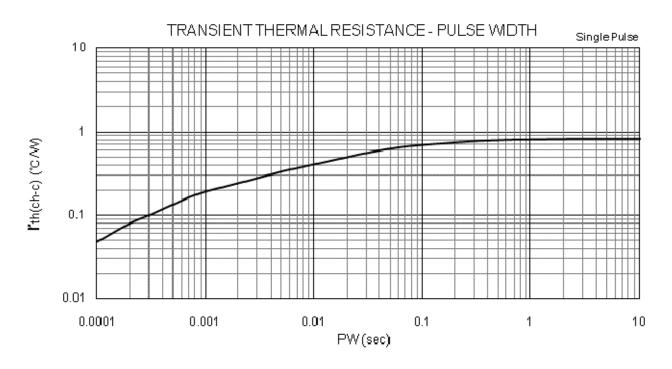
Capacitance - VDS characteristics (typical) G=1MHz



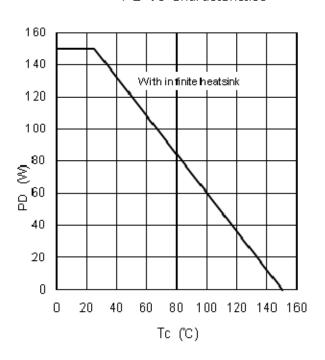
IDR - VSD characteristics (typical)



# Characteristic Curves (Tc=25°C)



#### PD-Tc characteristics



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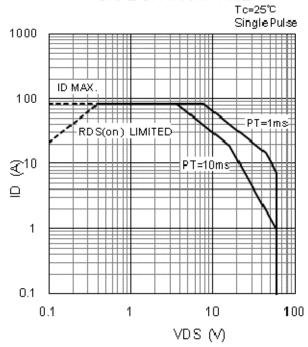


Fig.1 Unclamped Inductive Test Method

EAS=
$$\frac{1}{2} \cdot L \cdot ILP^2 \cdot \frac{V(BR)DSS}{V(BR)DSS - VDD}$$

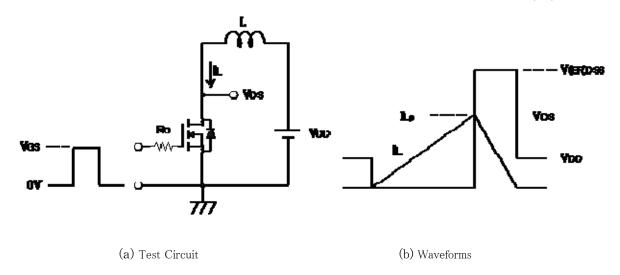
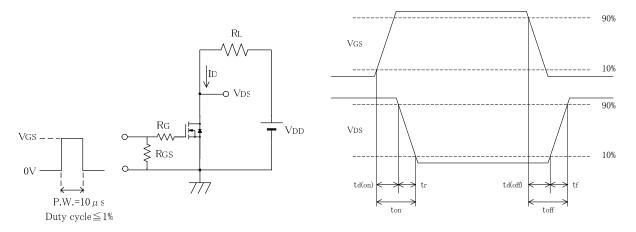


Fig.2 Switching Time Test Method



(a) Test Circuit

(b) Waveforms

# **Outline**

MT100 (TO3P)

